

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HISANORI AKIMARU	10/26/2016
KENJI OKAMOTO	10/26/2016
HIROKAZU SAKAKIBARA	10/26/2016
MAKOTO KATSURAYAMA	10/26/2016
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<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15361010
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<b>ATTORNEY DOCKET NUMBER:</b>	65730-US-618
<b>NAME OF SUBMITTER:</b>	BELINDA LEE
<b>SIGNATURE:</b>	/Belinda Lee/
<b>DATE SIGNED:</b>	11/30/2016
<b>Total Attachments: 2</b>	
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## Assignment of Application

INSERT NAMES  
AND RESIDENCE  
ADDRESS OF  
THE INVENTORS:

WHEREAS, I (WE) 1) Hisanori AKIMARU, 2) Kenji OKAMOTO, 3) Hirokazu SAKAKIBARA and 4) Makoto KATSURAYAMA of c/o JSR CORPORATION, 9-2, Higashi-Shinbashi 1-chome, Minato-ku, Tokyo 1058640 Japan, respectively,

INSERT TITLE OF  
INVENTION:

have invented certain new and useful improvements in: "PHOTOSENSITIVE RESIN COMPOSITION, METHOD FOR FORMING RESIST PATTERN, AND METHOD FOR PRODUCING METALLIC PATTERN"

(Application No. \_\_\_\_\_, filed \_\_\_\_\_), and

INSERT NAMES  
AND ADDRESS OF  
COMPANY OR  
OTHER ASSIGNEE:

WHEREAS, JSR CORPORATION  
(hereinafter referred to as "ASSIGNEE") having a place of business at : 9-2, Higashi-Shinbashi 1-chome, Minato-ku, Tokyo 1058640 Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I(WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right; title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE of 7F-1, 100, Roosevelt Rd. Sec. 2

Taipei, Taiwan, R.O.C. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: October 26, 2016

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Signature of Inventor: Hisanori AKIMARU

Date: October 26, 2016

岡本 健司  
Signature of Inventor: Kenji OKAMOTO

Date: October 26, 2016

榑 康 宏和  
Signature of Inventor: Hirokazu SAKAKIBARA

Date: October 26, 2016

桂山 真  
Signature of Inventor: Makoto KATSURAYAMA

Date: \_\_\_\_\_

Signature of Inventor: \_\_\_\_\_

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